

Transaction Information

Tool ID	TRK353
Tool Status	Connected
Location	Dresden, Germany
Wafer Size	300 mm
Fab Section	Lithography
Tool Available Date	2024-01-01

General Product Information

Vendor Supplier	TEL
Model	PROi
Vintage	2010
Serial No	N100355
Asset Description	Coater Developer Litography
Software Version	100.0.90.2
CIM	SECS, GEM
Process	Cot / DEV

Hardware Configuration (Fab)

System Type	Description	Quantity	Status
Handler System	PRA/CRA/IRAI/PRAI	7	OK
Options System			
Factory Interface	FOUP	5	OK
Main System	COT/DEV	1	OK
Others			

Hardware Configuration (Subfab / Auxilliary Units)

Description	Quantity	Status
RESIST CABINET	1	OK
Chiller Original	1	OK
A/C POWER BOX	1	OK
T/H CONTR.	1	OK
DEV. CABINET	1	OK
COT CABINET	1	OK

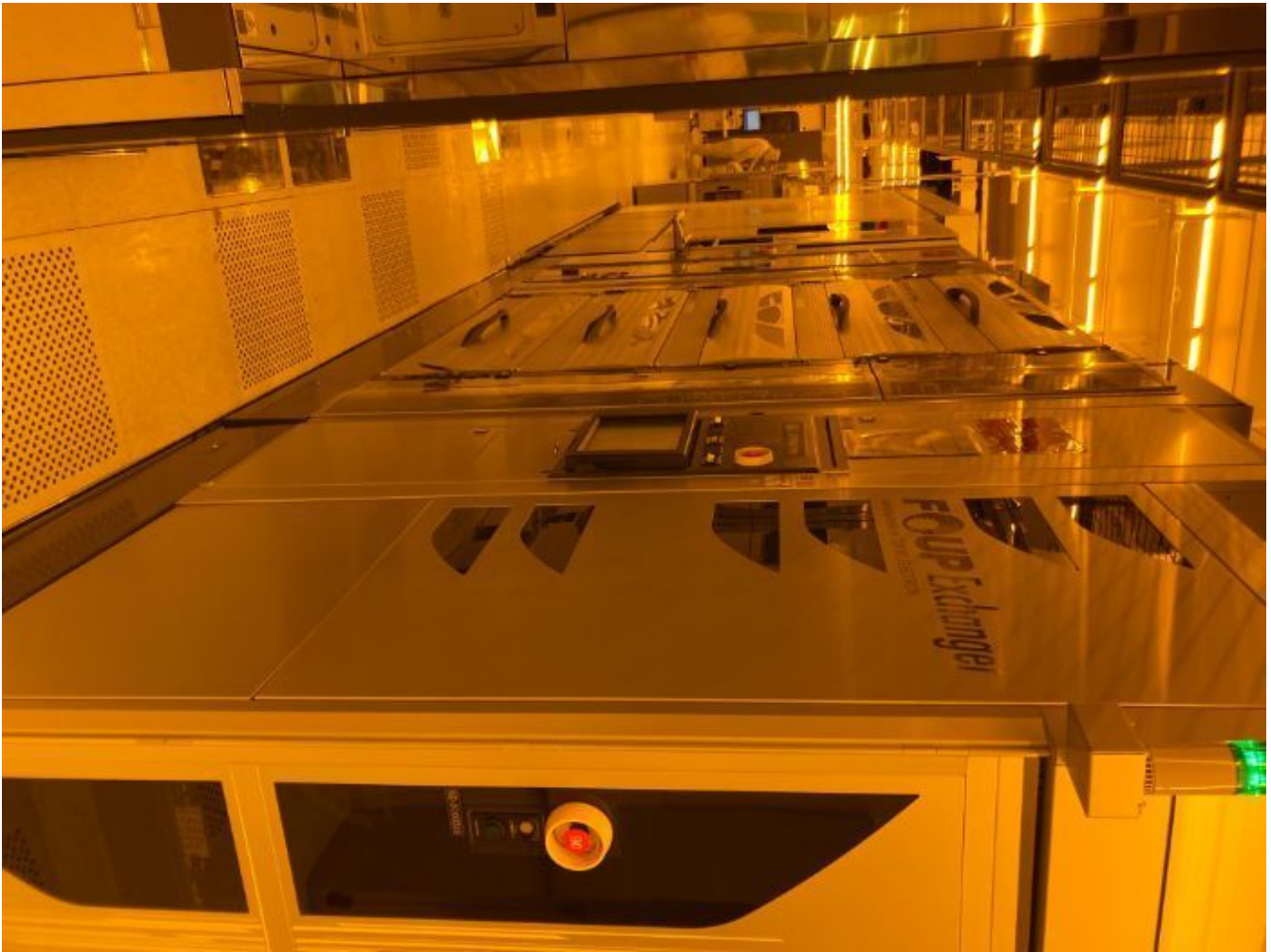
Missing/Faulty Parts / Accesories List

Description	Quantity
NONE	

Tool Pictures

General

MainBody



General

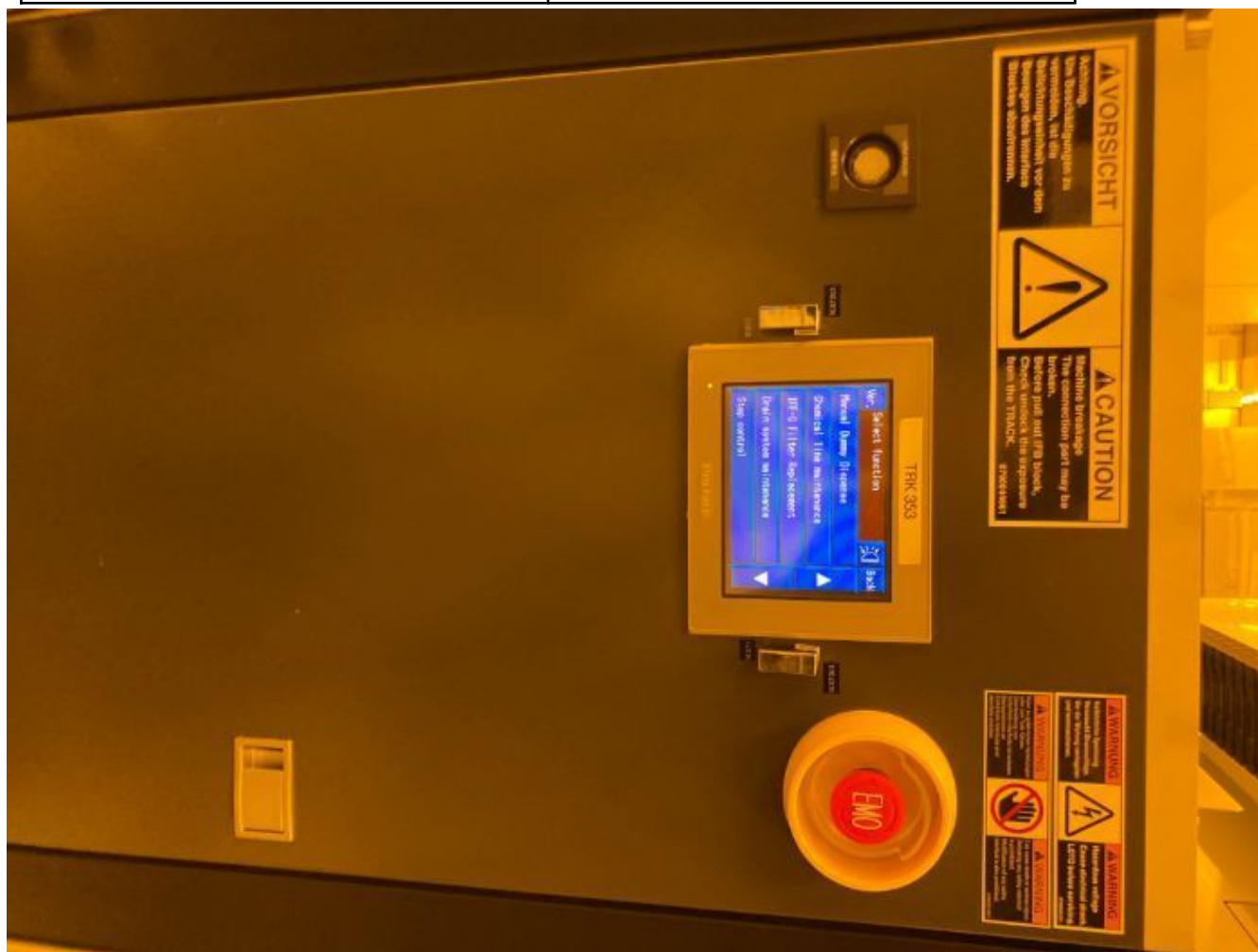
MainBody



General

MainBody





General

MainBody



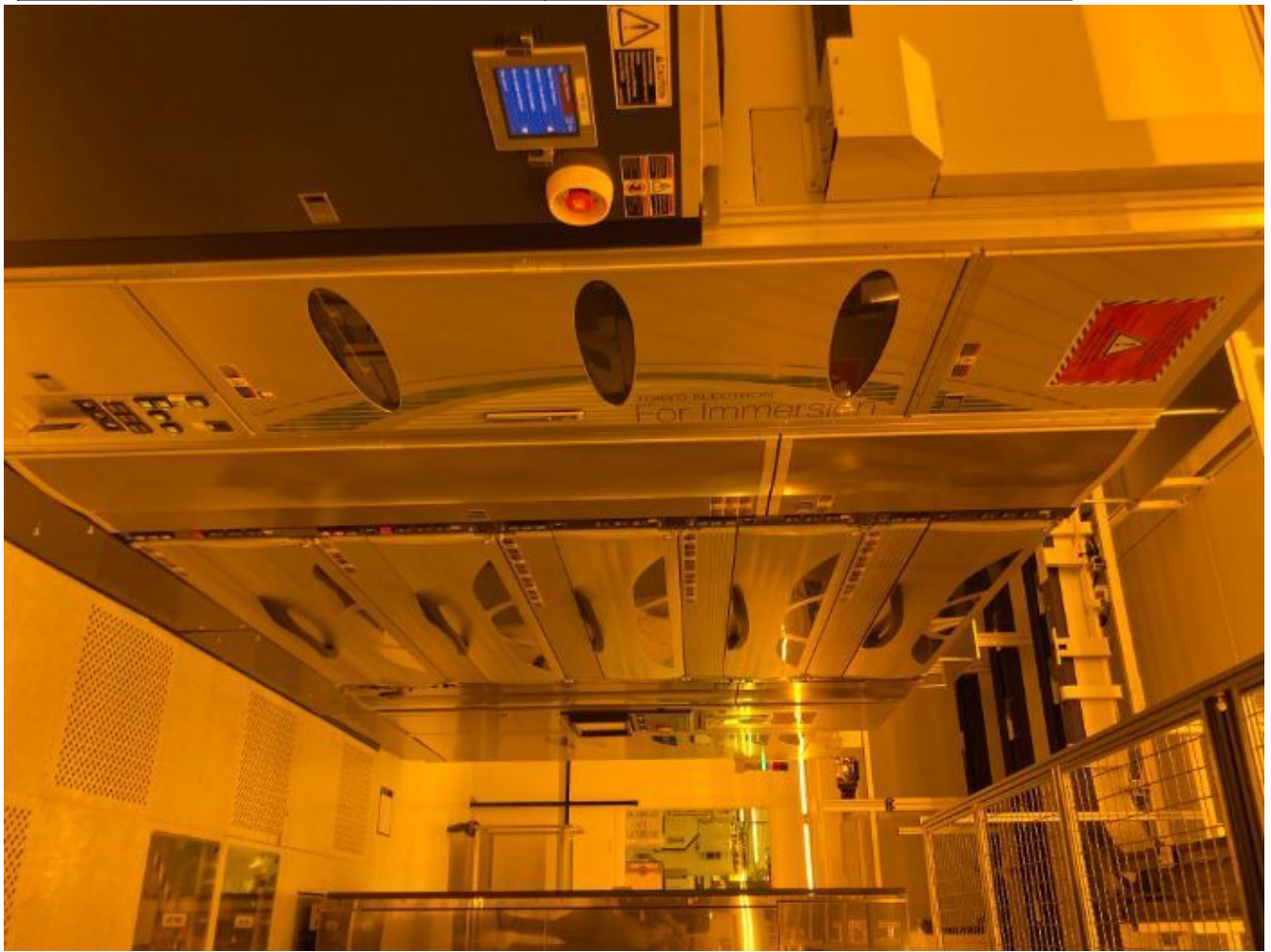
General

MainBody



General

MainBody



N100355E012

1 CONFIGURATION

CONFIGURATION

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東京エレクトロン九州株式会社
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		6-21 CPHP	6-22 CPHP	6-23 CPHP	6-24 WEE				
		6-11 CPHP	6-12 CPHP	6-13 CPHP	6-14 WEE				
6-51 CNH*3		6-0 PRA				2-46 SBU*4			
6-50						2-45 TRS			
6-49 WISC						2-44 SCPL			
						2-43 SCPL			
		6-1 COT	6-2 COT	6-3 COT					
		5-21 CGRA	5-22 CGRA	5-23 CHHA	5-24 CHHA				
		5-11 CGRA	5-12 CGRA	5-13 CHHA	5-14 CHHA	2-37 SBU*6			
7-6 PIR	5-51 CNH*3	5-0 PRA				2-36 SBU*4			
7-5 BST						2-35 TRS			
7-4 BST	5-50					2-34 SCPL			
	5-49					2-33 SCPL			
		5-1 ITC	5-2 ITC	5-3 ITC				1-5 FOUN	
		4-21 CADH	4-22 CADH	4-23 CGRA	4-24 CGRA				
		4-11 CADH	4-12 CADH	4-13 CGRA	4-14 CGRA	2-26 SBU*4			
	4-51 CNH*3	4-0 PRA				2-25 TRS		1-4 FOUN	
						2-24 SCPL			
						2-23 SCPL			
	4-50					2-22 TRS			
	4-49					2-21 TRS			
		4-1 BCT	4-2 BCT	4-3 BCT				1-3 FOUN	
		7-20 ISHU							
		3-31 CSWP	3-32 CSWP	3-33	3-34				
	7-3 PIR	7-17	3-21 CSWP	3-22 CSWP	3-23 CGRA	3-24 CGRA			
	7-2 PIR	7-16	3-11 CSWP	3-12 CSWP	3-13 CGRA	3-14 CGRA			
	7-1 BST		3-0 PRA				2-17 CPL		1-2 FOUN
	7-26 RSN	7-15 TRS					2-16 CPL		
	7-25 RSN	7-14 TRS					2-15		
	7-24 TRS	3-42 CPL							
	7-23 TRS	3-41 CPL							
	7-22 ROPL		3-4 DEV	3-5 DEV	3-6 DEV		2-0 MPRA		
	7-21 ROPL		3-1 DEV	3-2 DEV	3-3 DEV				

*本図はCONF16の情報のみ示しています。

** This figure shows only module configuration.

1-10 w/o FOUN Exchanger

Manufacture Serial

Serial Plate



Additional Tool Data Files